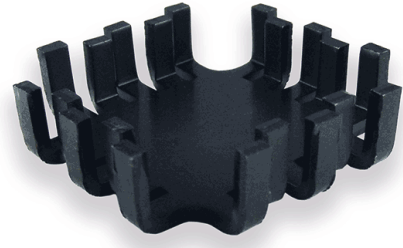


## Product Data Sheet Type: FI310/SE

Group: HEATSINKS Board Level

For single mounting

Width :	46 mm
Height :	12.7 mm
Length :	46 mm
Minimum thermal resistance :	7 K/W
Device mounted by :	Screw
Heatsink mounted by :	Srew-On
Surface :	Black Anodised
Material :	Al99,5



Finger shaped heatsink, with no hole pattern, e.g. for semiconductor case TO3.  
Space saving construction.  
Turbulence in every installation position.

